# General Purpose Transistors

## **PNP Silicon**

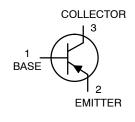
#### Features

• These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant



## **ON Semiconductor®**

http://onsemi.com



#### **MAXIMUM RATINGS** ( $T_A = 25^{\circ}C$ unless otherwise noted)

Rating		Symbol	Value	Unit
Collector-Emitter Voltage	BC856	V <sub>CEO</sub>	-65	V
_	BC857		-45	
BC8		-30		
Collector-Base Voltage	BC856	V <sub>CBO</sub>	-80	V
	BC857		-50	
BC8		-30		
Emitter-Base Voltage		V <sub>EBO</sub>	-5.0	V
Collector Current – Continuous		Ι <sub>C</sub>	-100	mAdc

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR-5 Board, (Note 1) T <sub>A</sub> = 25°C Derate above 25°C	P <sub>D</sub>	225 1.8	mW mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	556	°C/W
Total Device Dissipation Alumina Substrate, (Note 2) T <sub>A</sub> = 25°C Derate above 25°C	P <sub>D</sub>	300 2.4	mW mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	417	°C/W
Junction and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

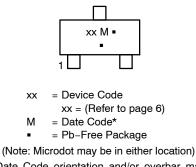
1. FR-5 =  $1.0 \times 0.75 \times 0.062$  in.

2. Alumina = 0.4 x 0.3 x 0.024 in 99.5% alumina.



SOT-23 (TO-236AB) CASE 318 STYLE 6

### MARKING DIAGRAM



\*Date Code orientation and/or overbar may vary depending upon manufacturing location.

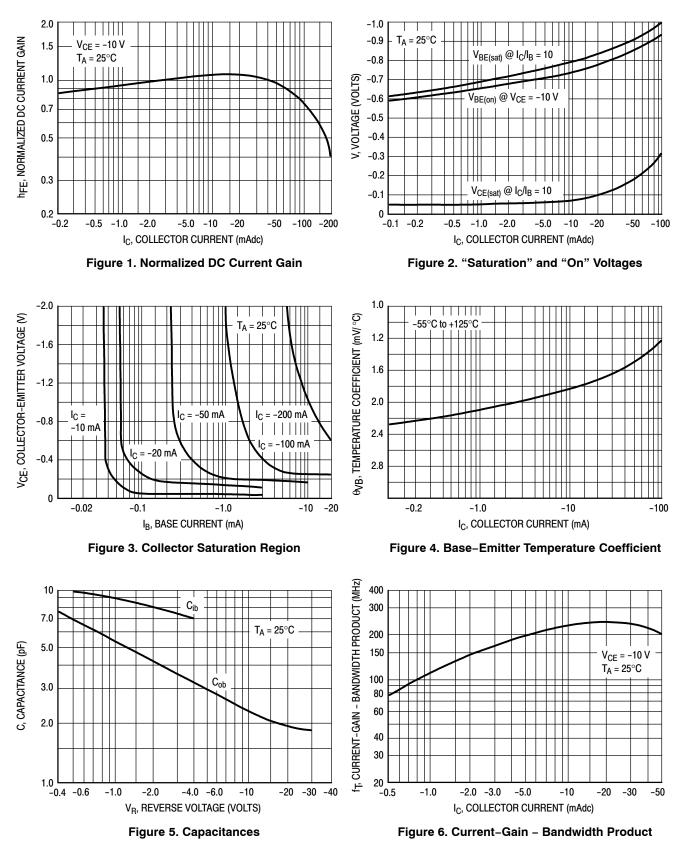
#### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 6 of this data sheet.

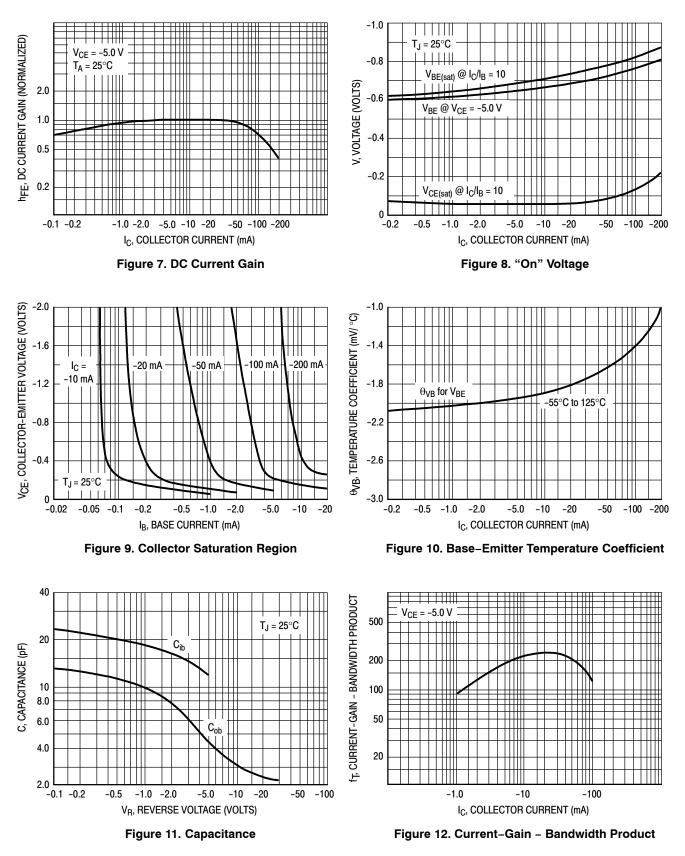
# **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = $25^{\circ}$ C unless otherwise noted)

Characterist	Symbol	Min	Тур	Max	Unit	
OFF CHARACTERISTICS			•		•	•
Collector – Emitter Breakdown Voltage (I <sub>C</sub> = –10 mA)	BC856 Series BC857 Series BC858, BC859 Series	V <sub>(BR)CEO</sub>	-65 -45 -30	- - -	- - -	V
Collector – Emitter Breakdown VoltageBC856 Series $(I_C = -10 \ \mu\text{A}, V_{EB} = 0)$ BC857A, BC857B OnlyBC858, BC859 Series		V <sub>(BR)CES</sub>	-80 -50 -30	- - -	- - -	V
Collector – Base Breakdown Voltage ( $I_C = -10 \ \mu A$ )	BC856 Series BC857 Series BC858, BC859 Series	V <sub>(BR)CBO</sub>	-80 -50 -30	- - -	- - -	V
Emitter – Base Breakdown Voltage ( $I_E = -1.0 \ \mu A$ )	BC856 Series BC857 Series BC858, BC859 Series	V <sub>(BR)EBO</sub>	-5.0 -5.0 -5.0	- - -	- - -	V
Collector Cutoff Current (V <sub>CB</sub> = $-30$ V) (V <sub>CB</sub> = $-30$ V, T <sub>A</sub> =	Collector Cutoff Current (V <sub>CB</sub> = $-30$ V) (V <sub>CB</sub> = $-30$ V, T <sub>A</sub> = $150^{\circ}$ C)				-15 -4.0	nA μA
ON CHARACTERISTICS			Į	ļ	4	Į
$(I_{C} = -10 \ \mu A, V_{CE} = -5.0 \ V)$ BC856	A, BC857A, BC858A B, BC857B, BC858B C, BC858C	h <sub>FE</sub>		90 150 270	- - -	-
BC856	A, BC857A, BC858A B, BC857B, BC858B, BC859B C, BC858C, BC859C		125 220 420	180 290 520	250 475 800	
Collector – Emitter Saturation Voltage ( $I_C = -10 \text{ mA}, I_B = -0.5 \text{ mA}$ ) ( $I_C = -100 \text{ mA}, I_B = -5.0 \text{ mA}$ )	V <sub>CE(sat)</sub>			-0.3 -0.65	V	
Base – Emitter Saturation Voltage ( $I_C = -10 \text{ mA}, I_B = -0.5 \text{ mA}$ ) ( $I_C = -100 \text{ mA}, I_B = -5.0 \text{ mA}$ )	V <sub>BE(sat)</sub>		-0.7 -0.9		V	
Base – Emitter On Voltage ( $I_C = -2.0 \text{ mA}, V_{CE} = -5.0 \text{ V}$ ) ( $I_C = -10 \text{ mA}, V_{CE} = -5.0 \text{ V}$ )	V <sub>BE(on)</sub>	-0.6 -		-0.75 -0.82	V	
SMALL-SIGNAL CHARACTERISTICS						
Current-Gain – Bandwidth Product ( $I_C = -10$ mA, $V_{CE} = -5.0$ Vdc, f = 100 MHz)		f <sub>T</sub>	100	_	-	MHz
Output Capacitance (V <sub>CB</sub> = -10 V, f = 1.0 MHz)	C <sub>ob</sub>	-	-	4.5	pF	
Noise Figure (I <sub>C</sub> = -0.2 mA, V <sub>CE</sub> = -5.0 Vdc, R <sub>S</sub> = 2.0 BC856, BC859	BC857, BC858 Series	NF			10 4.0	dB

#### BC857/BC858/BC859







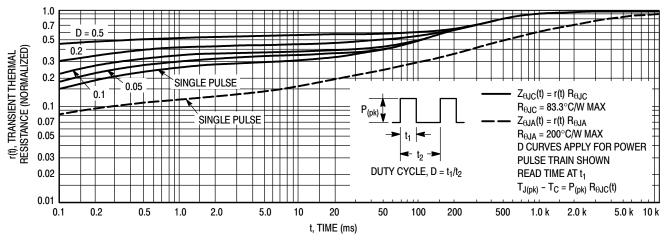


Figure 13. Thermal Response

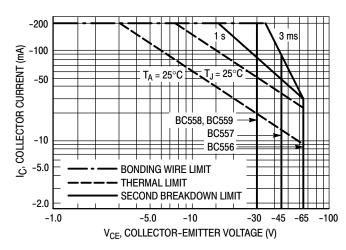


Figure 14. Active Region Safe Operating Area

The safe operating area curves indicate  $I_C-V_{CE}$  limits of the transistor that must be observed for reliable operation. Collector load lines for specific circuits must fall below the limits indicated by the applicable curve.

The data of Figure 14 is based upon  $T_{J(pk)} = 150^{\circ}C$ ;  $T_C$  or  $T_A$  is variable depending upon conditions. Pulse curves are valid for duty cycles to 10% provided  $T_{J(pk)} \le 150^{\circ}C$ .  $T_{J(pk)}$  may be calculated from the data in Figure 13. At high case or ambient temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by the secondary breakdown.

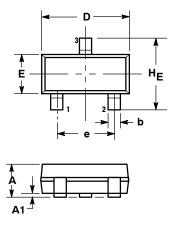
#### **ORDERING INFORMATION**

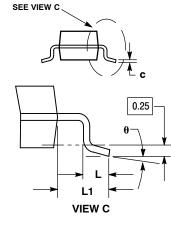
Device	Marking	Package	Shipping <sup>†</sup>		
BC856ALT1G		SOT-23 (Pb-Free)	3,000 / Tape & Reel		
BC856ALT3G		SOT-23 (Pb-Free)	10,000 / Tape & Reel		
BC856BLT1G		SOT-23 (Pb-Free)	3,000 / Tape & Reel		
BC856BLT3G		SOT-23 (Pb-Free)	10,000 / Tape & Reel		
BC857ALT1G	3E	SOT-23 (Pb-Free)			
BC857BLT1G		SOT-23 (Pb-Free)	3,000 / Tape & Reel		
BC857BLT3G		SOT-23 (Pb-Free)	10,000 / Tape & Reel		
BC857CLT1G		SOT-23 (Pb-Free)	3,000 / Tape & Reel		
BC857CLT3G		SOT-23 (Pb-Free)	10,000 / Tape & Reel		
BC858ALT1G	ЗJ	SOT-23 (Pb-Free)			
BC858BLT1G	зк	SOT-23 (Pb-Free)	3,000 / Tape & Reel		
BC858BLT3G		SOT-23 (Pb-Free)	10,000 / Tape & Reel		
BC858CLT1G	3L	SOT-23 (Pb-Free)	3,000 / Tape & Reel		
BC858CLT3G		SOT-23 (Pb-Free)	10,000 / Tape & Reel		
BC859BLT1G		SOT-23 (Pb-Free)	3,000 / Tape & Reel		
BC859BLT3G		SOT-23 (Pb-Free)	10,000 / Tape & Reel		
BC859CLT1G		SOT-23 (Pb-Free)	3,000 / Tape & Reel		
BC859CLT3G		SOT-23 (Pb-Free)	10,000 / Tape & Reel		

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### PACKAGE DIMENSIONS

SOT-23 (TO-236) CASE 318-08 **ISSUE AN** 





NOTES:

- 1.
- TES: DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. CONTROLLING DIMENSION: INCH. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS, MINIMUM LEAD THICKNESS IS THE MINIMUM З.
- THICKNESS OF BASE MATERIAL. 318-01 THRU -07 AND -09 OBSOLETE, NEW STANDARD 4 318-08.

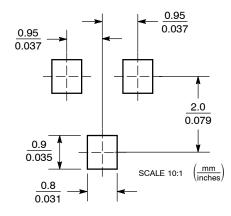
	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.89	1.00	1.11	0.035	0.040	0.044
A1	0.01	0.06	0.10	0.001	0.002	0.004
b	0.37	0.44	0.50	0.015	0.018	0.020
c	0.09	0.13	0.18	0.003	0.005	0.007
D	2.80	2.90	3.04	0.110	0.114	0.120
Е	1.20	1.30	1.40	0.047	0.051	0.055
е	1.78	1.90	2.04	0.070	0.075	0.081
Г	0.10	0.20	0.30	0.004	0.008	0.012
L1	0.35	0.54	0.69	0.014	0.021	0.029
ΗE	2.10	2.40	2.64	0.083	0.094	0.104

STYLE 6:	

PIN 1. BASE EMITTER

2 COLLECTOR 3.

#### **SOLDERING FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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